

## Aluminum Electrolytic Capacitors SMD (Chip) Long Life



Fig. 1

RoHS  
COMPLIANT

### FEATURES

- Useful life: 2000 h at 105 °C
- Flexible terminals, reflow and wave solderable
- Compact, rectangular shape
- Charge and discharge proof, no peak current limitation
- Polarized aluminum electrolytic capacitors, non-solid electrolyte, self healing
- Extended voltage and capacitance range
- SMD-version, fully molded, insulated
- Supplied in blister tape on reel
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### APPLICATIONS

- SMD technology
- Industrial and professional applications
- Telecommunications, automotive, EDP general industrial
- Coupling, decoupling, smoothing, filtering, buffering, timing

### MARKING

- Rated capacitance (in  $\mu\text{F}$ )
- Rated voltage (in V)
- Date code in accordance with IEC 60062
- Name of manufacturer
- “-” sign indicating the cathode. The anode is identified by bevelled edges
- Series number (139)

QUICK REFERENCE DATA	
DESCRIPTION	VALUE
Nominal case sizes (L x W x H in mm)	14.3 x 6.2 x 6.9 and 14.3 x 7.6 x 8.2
Rated capacitance range, $C_R$	1.0 $\mu\text{F}$ to 220 $\mu\text{F}$
Tolerance on $C_R$	$\pm 20\%$
Rated voltage range, $U_R$	6.3 V to 100 V
Category temperature range	-55 °C to +105 °C
Endurance test at 105 °C	1000 h
Useful life at 105 °C	2000 h
Useful life at 40 °C; 1.3 x $I_R$ applied	200 000 h
Shelf life at 0 V, 105 °C	500 h
Resistance to soldering heat test	Immersion in solder: 10 s at 260 °C or 40 s at 215 °C
Based on sectional specification	IEC 60384-18 / CECC 32300
Climatic category IEC 60068	55 / 105 / 56

SELECTION CHART FOR $C_R$ , $U_R$ , AND RELEVANT NOMINAL CASE SIZES (L x W x H in mm)								
$C_R$ ( $\mu\text{F}$ )	$U_R$ (V)							
	6.3	10	16	25	40	50	63	100
1.0	-	-	-	-	-	-	-	14.3 x 6.2 x 6.9
2.2	-	-	-	-	-	-	14.3 x 6.2 x 6.9	14.3 x 6.2 x 6.9
3.3	-	-	-	-	-	-	14.3 x 6.2 x 6.9	14.3 x 7.6 x 8.2
4.7	-	-	-	-	-	-	14.3 x 6.2 x 6.9	14.3 x 7.6 x 8.2
10	-	-	-	14.3 x 6.2 x 6.9	-	14.3 x 6.2 x 6.9	14.3 x 7.6 x 8.2	-
15	-	-	-	-	14.3 x 6.2 x 6.9	14.3 x 7.6 x 8.2	-	-
22	-	-	-	14.3 x 6.2 x 6.9	-	14.3 x 7.6 x 8.2	-	-
33	-	-	-	-	14.3 x 7.6 x 8.2	-	-	-

SELECTION CHART FOR $C_R$ , $U_R$ , AND RELEVANT NOMINAL CASE SIZES (L x W x H in mm)								
$C_R$ ( $\mu F$ )	$U_R$ (V)							
	6.3	10	16	25	40	50	63	100
47	-	-	14.3 x 6.2 x 6.9	14.3 x 7.6 x 8.2	-	-	-	-
68	-	14.3 x 6.2 x 6.9	-	-	-	-	-	-
100	14.3 x 6.2 x 6.9	-	14.3 x 7.6 x 8.2	-	-	-	-	-
150	-	14.3 x 7.6 x 8.2	-	-	-	-	-	-
220	14.3 x 7.6 x 8.2	-	-	-	-	-	-	-

**DIMENSIONS** in millimeters

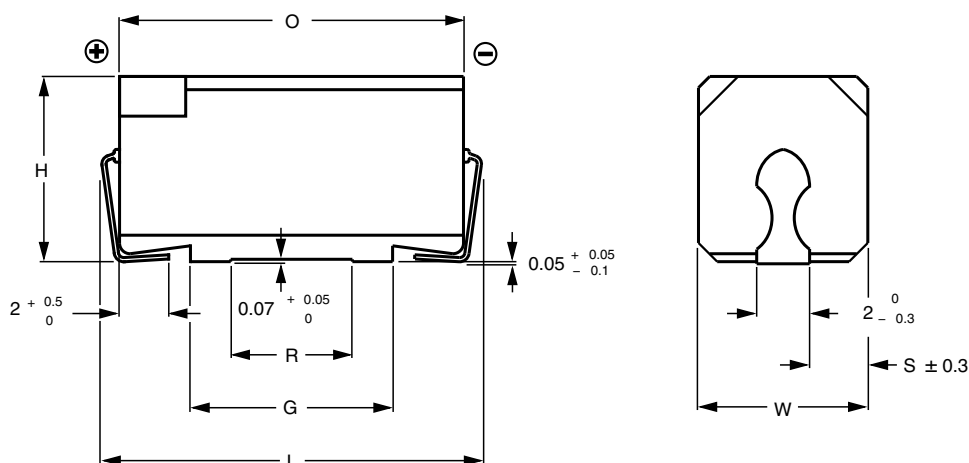


Fig. 2 - Dimensional outline

Table 1

DIMENSIONS in millimeters, MASS AND PACKAGING QUANTITIES										
NOMINAL CASE SIZE L x W x H	CASE CODE	$L_{max.}$	$W_{max.}$	$H_{max.}$	$O_{max.}$	S	$G_{max.}$	$R_{min.}$	MASS (g)	PACKAGING QUANTITIES PER REEL
14.3 x 6.2 x 6.9	2	14.5	6.3	7.05	13.0	2.15	7.5	4.7	≈ 0.95	700
14.3 x 7.6 x 8.2	3	14.5	7.7	8.35	13.0	2.85	7.5	4.7	≈ 1.3	700

**Note**

- For detailed tape dimensions please see [www.vishay.com/doc?28359](http://www.vishay.com/doc?28359)



Table 2

RECOMMENDED SOLDERING PAD DIMENSIONS in millimeters (placement accuracy $\pm 0.25$ mm)														
NOMINAL CASE SIZE L x W x H	FOR REFLOW SOLDERING							FOR WAVE SOLDERING						
	A	B	C	D	E	F	G	A	B	C	D	E	F	G
14.3 x 6.2 x 6.9	15.8	8.8	3.5	2.8	8.0	16.2	7.7	18.6	10.0	4.3	5.0	8.8	20.5	11.5
14.3 x 7.6 x 8.2	15.8	8.8	3.5	2.8	8.0	16.2	9.1	18.6	10.0	4.3	6.0	8.8	21.5	13.0

**MOUNTING**

The capacitors are designed for automatic placement on to printed-circuit boards or hybrid circuits.

Optimum dimensions of soldering pads depend amongst others on soldering method, mounting accuracy, print lay-out and / or adjacent components.

For recommended soldering pad dimensions, refer to Fig. 3 and Table 2.

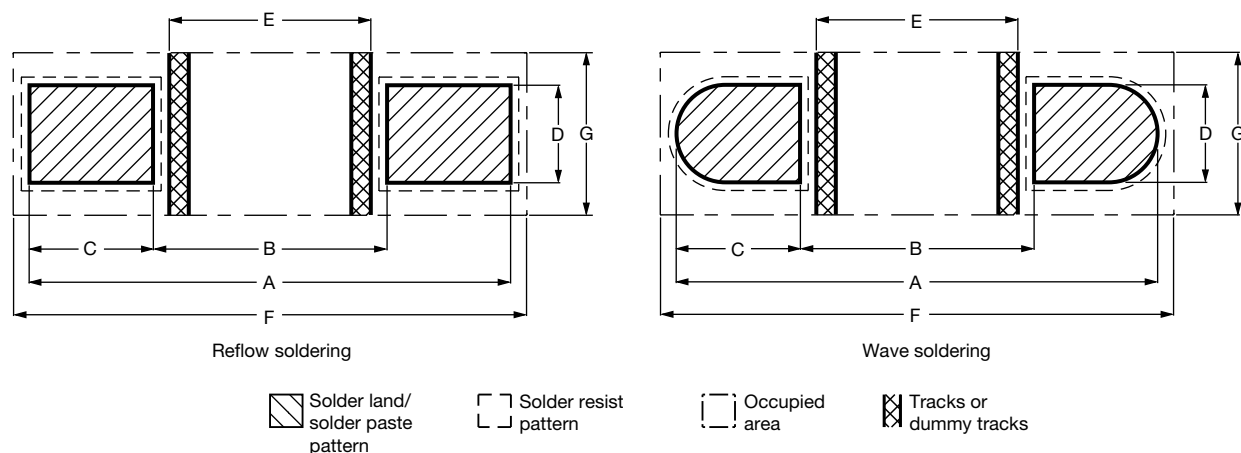


Fig. 3 - Recommended pad dimensions for reflow and wave soldering

**SOLDERING**

Soldering conditions are defined by the curve, temperature versus time, where the temperature is that measured on the soldering pad during processing.

For maximum conditions of different soldering methods see Fig. 4, 5, and 6.

Any temperature versus time curve which does not exceed the specified maximum curves may be applied.

AS A GENERAL PRINCIPLE, TEMPERATURE AND DURATION SHALL BE THE **MINIMUM** NECESSARY REQUIRED TO ENSURE GOOD SOLDERING CONNECTIONS. HOWEVER, THE SPECIFIED MAXIMUM CURVES SHOULD NEVER BE EXCEEDED.

Table 3

CURING CONDITIONS FOR SMD-GLUE	
MAX. T <sub>amb</sub> (°C)	MAX. EXPOSURE TIME (min)
125	30
140	10
150	5
160	2
160	2

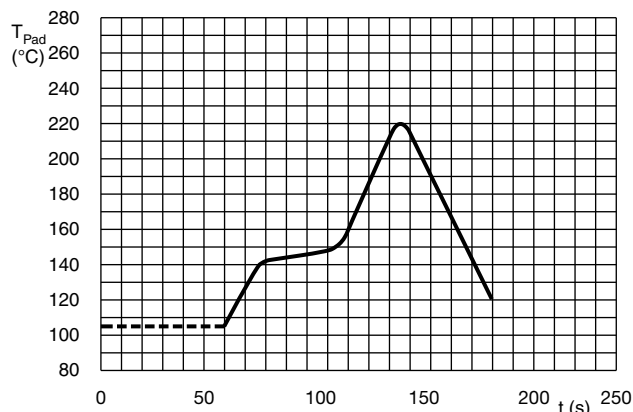


Fig. 4 - Maximum temperature load during infrared reflow soldering

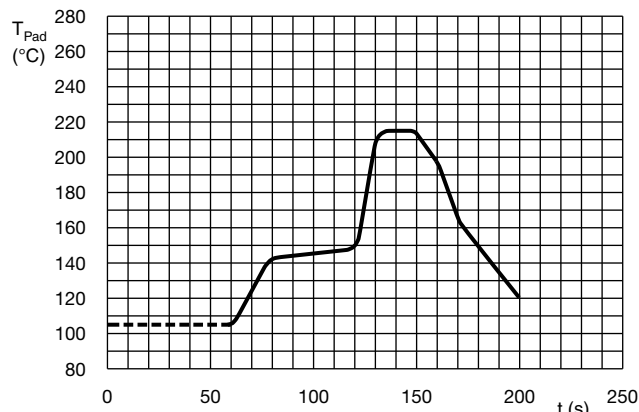


Fig. 5 - Maximum temperature load during vapor phase reflow soldering

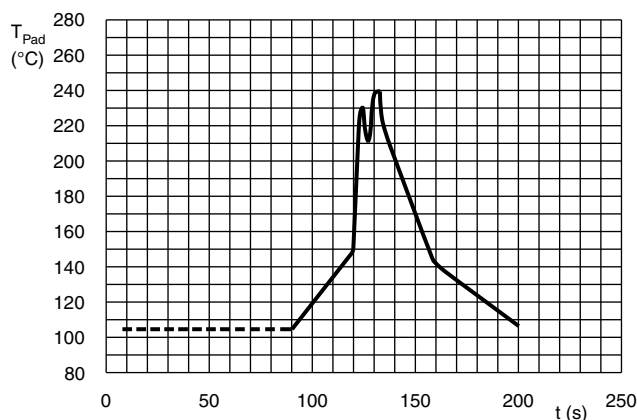


Fig. 6 - Maximum temperature load during (double-) wave soldering

ELECTRICAL DATA	
SYMBOL	DESCRIPTION
$C_R$	Rated capacitance at 100 Hz, tolerance $\pm 20\%$
$I_R$	Rated RMS ripple current at 100 Hz, 105 °C
$I_{L5}$	Max. leakage current after 5 min at $U_R$
$\tan \delta$	Max. dissipation factor at 100 Hz
$Z$	Max. impedance at 10 kHz

**Note**

- Unless otherwise specified, all electrical values in Table 4 apply at  $T_{amb} = 20\text{ °C}$ ,  $P = 86\text{ kPa}$  to  $106\text{ kPa}$ ,  $RH = 45\%$  to  $75\%$ .

**ORDERING EXAMPLE**

Electrolytic capacitor 139 series  
 100  $\mu\text{F}$  / 16 V;  $\pm 20\%$   
 Nominal case size: 14.3 mm x 7.6 mm x 8.2 mm  
 Taped on reel  
 Ordering code: MAL213965101E3  
 Former 12NC: 2222 139 65101



Table 4

ELECTRICAL DATA AND ORDERING INFORMATION							
$U_R$ (V)	$C_R$ 100 Hz ( $\mu$ F)	NOMINAL CASE SIZE L x W x H (mm)	$I_R$ 100 Hz 105 °C (mA)	$I_{L5}$ 5 min ( $\mu$ A)	$\tan \delta$ 100 Hz	Z 10 kHz ( $\Omega$ )	ORDERING CODE MAL2139.....
6.3	100	14.3 x 6.2 x 6.9	79	4.3	0.24	3.0	63101E3
	220	14.3 x 7.6 x 8.2	120	5.8	0.24	1.4	63221E3
10	68	14.3 x 6.2 x 6.9	71	4.4	0.20	2.9	64689E3
	150	14.3 x 7.6 x 8.2	110	6.0	0.20	1.3	64151E3
16	47	14.3 x 6.2 x 6.9	66	4.5	0.16	3.4	65479E3
	100	14.3 x 7.6 x 8.2	100	6.2	0.16	1.6	65101E3
25	10	14.3 x 6.2 x 6.9	40	3.5	0.09	12	66109E3
	22	14.3 x 6.2 x 6.9	48	4.1	0.14	5.5	66229E3
	47	14.3 x 7.6 x 8.2	79	5.4	0.14	2.6	66479E3
40	15	14.3 x 6.2 x 6.9	45	4.2	0.11	6	67159E3
	33	14.3 x 7.6 x 8.2	75	5.6	0.11	2.7	67339E3
50	10	14.3 x 6.2 x 6.9	40	4.0	0.09	7	61109E3
	15	14.3 x 7.6 x 8.2	56	4.5	0.09	4.7	61159E3
	22	14.3 x 7.6 x 8.2	67	5.2	0.09	3.2	61229E3
63	2.2	14.3 x 6.2 x 6.9	19	3.3	0.09	25	68228E3
	3.3	14.3 x 6.2 x 6.9	23	3.4	0.09	21	68338E3
	4.7	14.3 x 6.2 x 6.9	28	3.6	0.09	17	68478E3
	10	14.3 x 7.6 x 8.2	48	4.3	0.08	8	68109E3
100	1.0	14.3 x 6.2 x 6.9	12	3.2	0.09	55	69108E3
	2.2	14.3 x 6.2 x 6.9	19	3.4	0.09	29	69228E3
	3.3	14.3 x 7.6 x 8.2	27	3.7	0.08	17	69338E3
	4.7	14.3 x 7.6 x 8.2	33	3.9	0.08	11	69478E3

ADDITIONAL ELECTRICAL DATA		
PARAMETER	CONDITIONS	VALUE
<b>Voltage</b>		
Surge voltage for short periods		$U_s \leq 1.15 \times U_R$
Reverse voltage		$U_{rev} \leq 1 \text{ V}$
<b>Current</b>		
Leakage current	After 1 min at $U_R$	$I_{L1} \leq 0.02 C_R \times U_R + 3 \mu\text{A}$
	After 5 min at $U_R$	$I_{L5} \leq 0.002 C_R \times U_R + 3 \mu\text{A}$
<b>Inductance</b>		
Equivalent series inductance (ESL)	Nominal case size 14.3 mm x 6.2 mm x 6.9 mm	Typ. 18 nH
	Nominal case size 14.3 mm x 7.6 mm x 8.2 mm	Typ. 28 nH
<b>Resistance</b>		
Equivalent series resistance (ESR)	Calculated from $\tan \delta_{max.}$ and $C_R$ (see Table 4)	$ESR = \tan \delta / 2 \pi f C_R$



**CAPACITANCE**

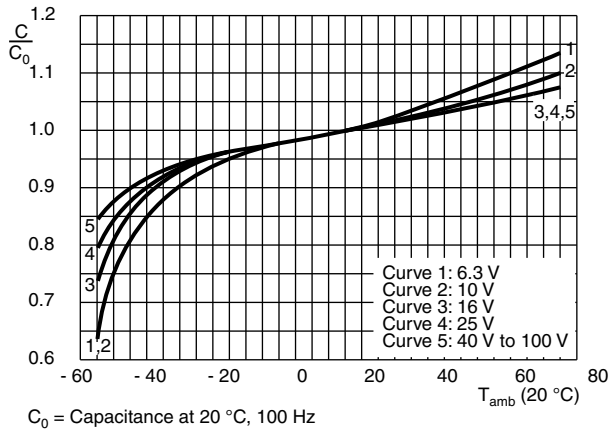


Fig. 7 - Typical multiplier of capacitance as a function of ambient temperature

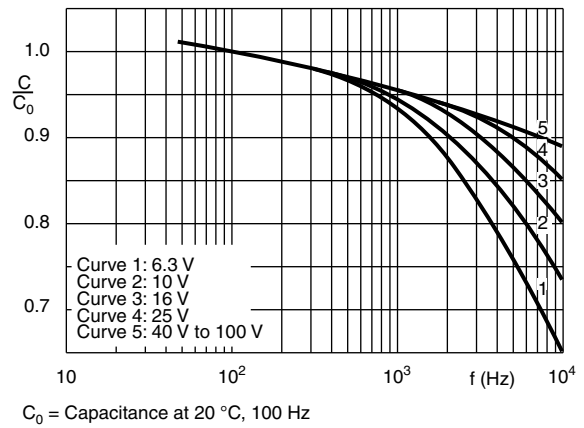
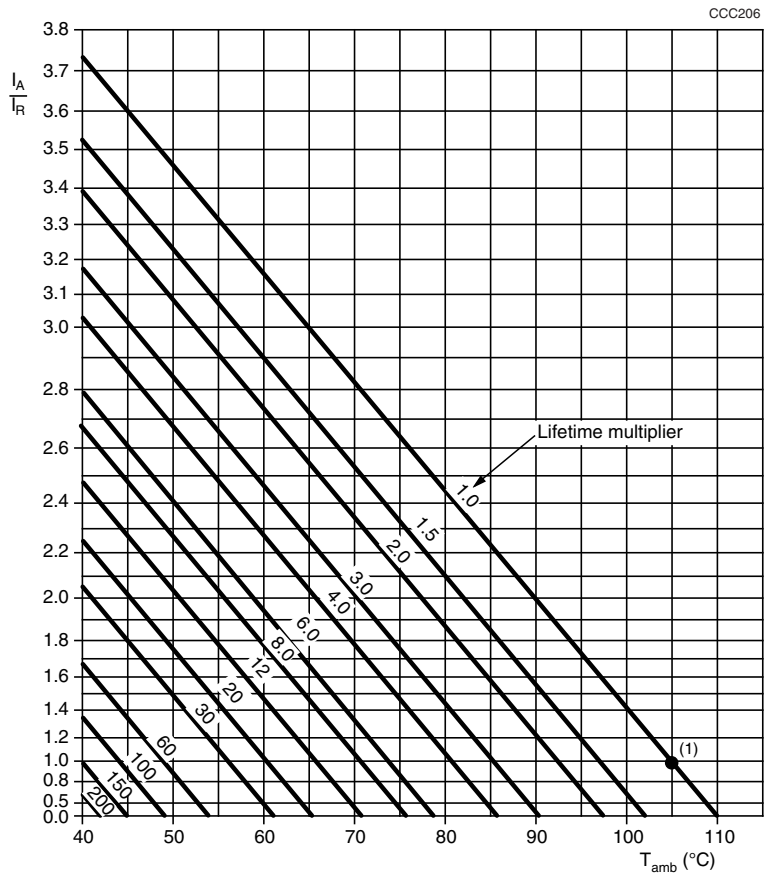


Fig. 8 - Typical multiplier of capacitance as a function of frequency

**RIPPLE CURRENT AND USEFUL LIFE**



$I_A$  = Actual ripple current at 100 Hz  
 $I_R$  = Actual ripple current at 100 Hz, 105 °C  
 (1) Useful life at 105 °C and  $I_R$  applied: 2000 h

Fig. 9 - Multiplier of useful life as a function of ambient temperature and ripple current load



MULTIPLIER OF RIPPLE CURRENT ( $I_R$ ) AS A FUNCTION OF FREQUENCY			
FREQUENCY (Hz)	$I_R$ MULTIPLIER		
	$U_R = 6.3 \text{ V TO } 16 \text{ V}$	$U_R = 25 \text{ V TO } 50 \text{ V}$	$U_R = 63 \text{ V TO } 100 \text{ V}$
50	0.95	0.90	0.85
100	1.00	1.00	1.00
300	1.07	1.12	1.20
1000	1.12	1.20	1.30
3000	1.15	1.25	1.35
$\geq 10\,000$	1.20	1.30	1.40

Table 5

TEST PROCEDURES AND REQUIREMENTS			
TEST		PROCEDURE (quick reference)	REQUIREMENTS
NAME OF TEST	REFERENCE		
Mounting	IEC 60384-18, subclause 4.3	Shall be performed prior to tests mentioned below; reflow or (double-) wave soldering; for maximum temperature load refer to chapter "Mounting"	$\Delta C/C: \pm 5 \%$ $\tan \delta \leq \text{spec. limit}$ $I_{L5} \leq \text{spec. limit}$
Endurance	IEC 60384-18 / CECC 32300, subclause 4.15	$T_{\text{amb}} = 105 \text{ }^\circ\text{C}$ ; $U_R$ applied; 1000 h	$U_R \leq 6.3 \text{ V } \Delta C/C: +15 \% / -30 \%$ $U_R \geq 10 \text{ V } \Delta C/C: \pm 15 \%$ $\tan \delta \leq 1.3 \times \text{spec. limit}$ $Z \leq 2 \times \text{spec. limit}$ $I_{L5} \leq \text{spec. limit}$
Useful life	CECC 30301, subclause 1.8.1	$T_{\text{amb}} = 105 \text{ }^\circ\text{C}$ ; $U_R$ and $I_R$ applied; 2000 h	$U_R \leq 6.3 \text{ V } \Delta C/C: +45 \% / -50 \%$ $U_R \geq 10 \text{ V } \Delta C/C: \pm 45 \%$ $\tan \delta \leq 3 \times \text{spec. limit}$ $Z \leq 3 \times \text{spec. limit}$ $I_{L5} \leq \text{spec. limit}$ no short or open circuit total failure percentage: $\leq 1 \%$
Shelf life (storage at high temperature)	IEC 60384-18 / CECC 32300, subclause 4.17	$T_{\text{amb}} = 105 \text{ }^\circ\text{C}$ ; no voltage applied; 500 h after test: $U_R$ to be applied for 30 min, 24 h to 48 h before measurement	For requirements see "Endurance test" above

Statements about product lifetime are based on calculations and internal testing. They should only be interpreted as estimations. Also due to external factors, the lifetime in the field application may deviate from the calculated lifetime. In general, nothing stated herein shall be construed as a guarantee of durability.



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